

DATA SHEET

SKY13296-340LF: GaAs SP4T Absorptive Switch 20 MHz-2.5 GHz

Features

- Positive voltage control (0/3 V to 0/5 V)
- High isolation 35 dB at 1 GHz
- Integrated silicon CMOS driver
- Isolated ports are absorptive
- Use of external DC blocks to allow good return loss to low frequency
- Available lead (Pb)-free and RoHS-compliant MSL-1 @ 260 °C per JEDEC J-STD-020

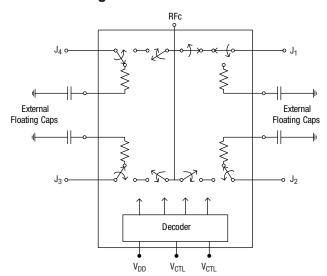
Description

The SKY13296-340LF is a pHEMT GaAs FET IC high isolation, absorptive single-pole four-throw switch packaged in a lead (Pb)-free, 4 x 4 mm, 20-lead exposed-pad plastic package for low-cost commercial applications. The use of external DC blocking capacitors on the RF ports and in series with the internal RF terminations enables the user to extend the range of good return loss to arbitrarily low frequency. This switch is an ideal building block for filter bank switching.



Skyworks offers lead (Pb)-free, RoHS (Restriction of Hazardous Substances)-compliant packaging.

Functional Diagram



Electrical Specifications

V_{CTL} = 0 V/3V, T = 25 °C, P_{INPUT} = 0 dBm, Z_0 = 50 Ω , C_{BLOCK} = 1000 pF, C_{BYPASS} = 1000 pF, unless otherwise noted

Parameter	Frequency	Min.	Тур.	Max.	Unit
Insertion loss	0.02-1.00 GHz		0.4	0.6	dB
	1.00-2.00 GHz		0.6	0.8	dB
	2.00-2.50 GHz		0.7	1.1	dB
Isolation	0.02-1.00 GHz	35	40		dB
	1.00-2.00 GHz	25	30		dB
	2.00-2.50 GHz	21	26		dB
Return loss (Insertion loss state)	0.02-1.00 GHz	12	18		dB
Lower freq. return loss is dependent on DC blocks	1.00-2.00 GHz	9	13		dB
	2.00-2.50 GHz	7	13		dB
Return loss (Isolation state)	0.02-1.00 GHz	9.5	14		dB
Lower freq. return loss is dependent on DC blocks and floating caps	1.00-2.00 GHz	8.0	11		dB
	2.00-2.50 GHz	7.0	9		dB

Operating Characteristics

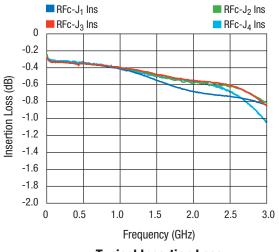
 V_{CTL} = 0 V/3V, T = 25 °C, P_{INPUT} = 0 dBm, Z_0 = 50 Ω , C_{BLOCK} = 1000 pF, C_{BYPASS} = 1000 pF, unless otherwise noted

Parameter	Condition	Frequency	Min.	Тур.	Max.	Unit
Switching characteristics						
Rise/fall time	10/90% or 90/10% RF			25		ns
On/Off time	50% V _{CTL} to 90/10% RF			50		ns
Input power for 0.1 dB compression	$V_{DD} = 3 V$	870 MHz	13	16		dBm
Intermodulation intercept point (IP3)	For two tone input power 8 dbm/tone 1 MHz spacing, V _{DD} = 3 V	900 MHz		40		dBm
Control voltages ⁽¹⁾	V _{CTL LOW}		0		0.2	V
	V _{CTL} HIGH		2.75		V_{DD}	V
Supply voltage (V _{DD})			3		5.5	V
Supply currents	$V_{DD} = 3 \text{ V}$			5		uA
	V _{CTL LOW} , V _{CTL HIGH}			5		uA

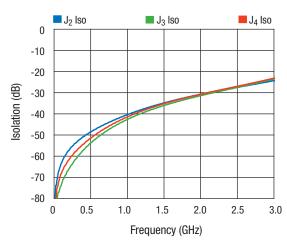
 $[\]overline{\text{1. Control voltages switch the V}_{\text{DD}}}$ voltage to the GaAs switch.

Typical Performance Data

 V_{CTL} = 0 V/3V, T = 25 °C, P_{INPUT} = 0 dBm, Z_0 = 50 Ω , C_{BLOCK} = 1000 pF, C_{BYPASS} = 1000 pF, unless otherwise noted

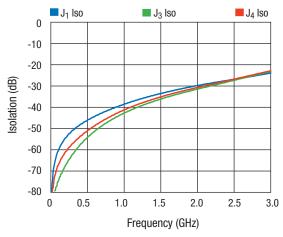


Typical Insertion Loss

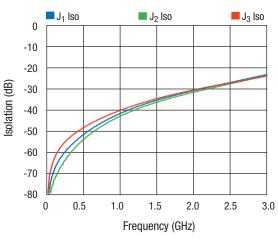


Typical Isolation RFc-J₁ Path On

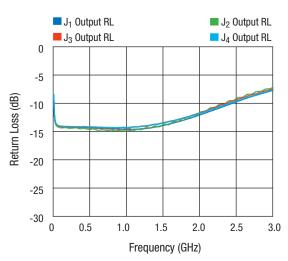
 V_{DD} must be powered on prior to a V_{CTL} high signal. A latch up condition may occur if a logic high signal is applied prior to the V_{DD} voltage.



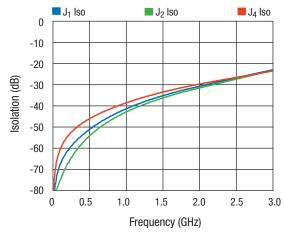
Typical Isolation RFc-J₂ Path On



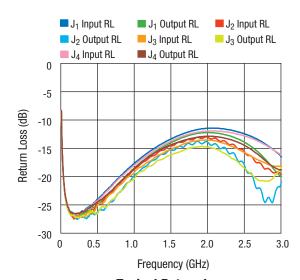
Typical Isolation RFc-J₄ Path On



Typical Return Loss Isolation States

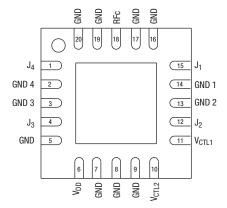


Typical Isolation RFc-J₃ Path On



Typical Return Loss Insertion Loss States

Pin Out (Top View X-ray of Pads on Bottom of Package)



DC blocks are required on RFc, J_1 , J_2 , J_3 , J_4 . Floating caps are required on Gnd 1, Gnd 2, Gnd 3, Gnd 4.

Truth Table

V _{DD}	V _{CTL 1}	V _{CTL 2}	RFc-J ₁	RFc-J ₂	RFc-J ₃	RFc-J ₄
1	0	0	Ins. Loss	Isolation	Isolation	Isolation
1	1	0	Isolation	Ins. Loss	Isolation	Isolation
1	0	1	Isolation	Isolation	Ins. Loss	Isolation
1	1	1	Isolation	Isolation	Isolation	Ins. Loss

 $\ensuremath{V_{DD}}$ must be powered on prior to a VCTL hgih signal.

"0" = 0 to 0.2 V.

"1" = $2.75 \text{ to V}_{DD} \text{ V}.$

 $V_{DD} = 3 \text{ V to 5 V}.$

Absolute Maximum Ratings

Characteristic	Value
V _{DD} voltage range	$2.75 \le V_{DD} \le 5.5 \text{ V}$
RF input power @ 5.5 V	1 W, f > 500 MHz
Operating temperature	-40 °C to +85 °C
Storage temperature	-65 °C to +150 °C

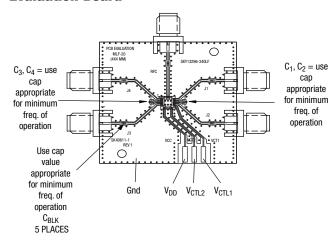
Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty.

CAUTION: Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

Pin Assignments

Pin	Symbol	Description	
1	J ₄	RF port. Must be DC blocked with a capacitor appropriate for lowest frequency of operation	
2	GND 4	AC Ground for J_4 RF port. Must be DC blocked using a capacitor appropriate for lowest frequency of desired input return loss on J_4 port	
3	GND 3	AC Ground for J_3 RF port. Must be DC blocked using a capacitor appropriate for lowest frequency of desired input return loss on J_3 port	
4	J ₃	RF port. Must be DC blocked with a capacitor appropriate for lowest frequency of operation	
5	GND	DC Ground	
6	V_{DD}	Supply voltage for decoder	
7	GND	DC Ground	
8	GND	DC Ground	
9	GND	DC Ground	
11	V _{CTL 1}	DC control voltage applied to decoder	
10	V _{CTL 2}	DC control voltage applied to decoder	
12	J ₂	RF port. Must be DC blocked with a capacitor appropriate for lowest frequency of operation	
13	GND 2	AC Ground for J ₂ RF port. Must be DC blocked using a capacitor appropriate for lowest frequency of desired input return loss on J ₂ port	
14	GND 1	AC Ground for J ₁ RF port. Must be DC blocked using a capacitor appropriate for lowest frequency of desired input return loss on J ₁ port	
15	J ₁	RF port. Must be DC blocked with a capacitor appropriate for lowest frequency of operation	
16	GND	DC Ground	
17	GND	DC Ground	
18	RFc	RF common port. Must be DC blocked with a capacitor appropriate for lowest frequency of operation	
19	GND	DC Ground	
20	GND	DC Ground	
Exposed Paddle		DC Ground	

Evaluation Board



 $C_{BLOCK} = 1000 \text{ pF}$ for operating frequency > 20 MHz. $C_{BYPASS} C_{1}-C_{4} = 1000 \text{ pF}$ for operating frequency > 20 MHz.

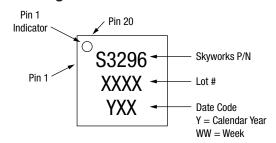
Recommended Solder Reflow Profiles

Refer to the "<u>Recommended Solder Reflow Profile</u>" Application Note.

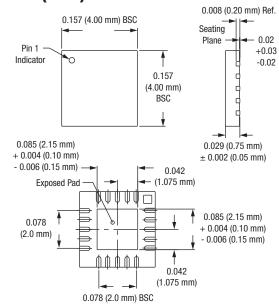
Tape and Reel Information

Refer to the "Discrete Devices and IC Switch/Attenuators Tape and Reel Package Orientation" Application Note.

Part Marking



QFN-20 (4 x 4)



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